

# STG4160

Datasheet - production data

# Low voltage 0.5 $\Omega$ single SPDT switch with break-before-make feature and 15 kV contact ESD protection

Flip Chip 8

#### Features

- Wide operating voltage range: V<sub>CC</sub> (opr.) = 1.65 to 4.8 V
- Low power dissipation:
   I<sub>CC</sub> = 0.2 μA (max.) at T<sub>A</sub> = 85 °C
- Low on-resistance:
  - $R_{ON} = 0.75 \Omega (T_A = 25 °C)$ at V<sub>CC</sub> = 2.25 V
  - $R_{ON}$  = 0.50  $\Omega$  (T<sub>A</sub> = 25 °C) at V<sub>CC</sub> = 3.0 V
  - $R_{ON}$  = 0.40  $\Omega$  (T<sub>A</sub> = 25 °C) at V<sub>CC</sub> = 4.3 V
- Separate supply voltage for switch and control pins
- Latch-up performance exceeds 100 mA per JESD 78, Class II
- ESD performance tested on common pin (D pin):
  - 15 kV IEC 61000-4-2 ESD, contact discharge
  - 8 kV HBM JESD22 A114-B Class II
- ESD performance tested on S1 and S2 pin: 8 kV IEC 61000-4-2 ESD, contact discharge
- ESD performance test on all other pins:
  - 4 kV HBM (JESD22 A114-B Class II)
  - 400 V machine model (JESD22 A115-A)
  - 1500 V charged-device model (JESD22 C101)

#### Applications

Mobile phones

### Description

The STG4160 device is a high-speed CMOS low voltage single analog SPDT (single pole dual throw) switch or 2:1 multiplexer/demultiplexer switch fabricated in silicon gate C<sup>2</sup>MOS technology. It is designed to operate from 1.65 to 4.8 V, making this device ideal for portable applications. It offers low on-resistance (0.40  $\Omega$  typ.) at V<sub>CC</sub> = 4.3 V. The SEL inputs are provided to control the switches.

The switch S1 is ON (connected to the common port D) when the SEL input is held high and OFF (high impedance state exists between the two ports) when the SEL is held low. The switch S2 is ON (connected to the common port D) when the SEL input is held low and OFF (high impedance state exist between the two ports) when the SEL is held high.

Additional key features are fast switching speed, break-before-make delay time and ultra power consumption. All inputs and outputs are equipped with protection circuits against static discharge, giving them ESD immunity and transient excess voltage.

Order code	Package	Packing		
STG4160BJR	Flip Chip 8	Tape and reel		

This is information on a product in full production.

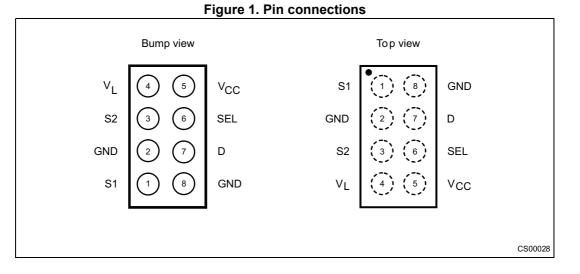
### Contents

1	Pin settings
	1.1 Pin connections
	1.2 Pin description
2	Logic diagram
3	Maximum ratings
4	Electrical characteristics
5	Test circuits
6	Package mechanical data 13
7	Package marking information17
8	Revision history



### 1 Pin settings

#### 1.1 Pin connections



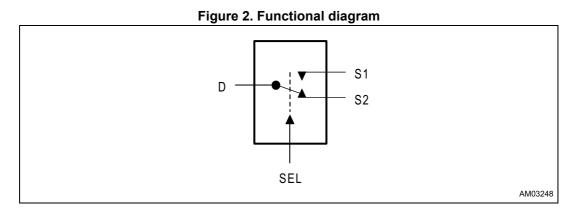
### 1.2 Pin description

Table 2. Pin assignment

Pin number	Symbol	Name and function
1	S1	Independent channel
2	GND	Ground (0 V)
3	S2	Independent channel
4	VL	Logic supply voltage
5	V <sub>CC</sub>	Positive supply voltage
6	SEL	Control
7	D	Common channel
8	GND	Ground (0 V)



# 2 Logic diagram





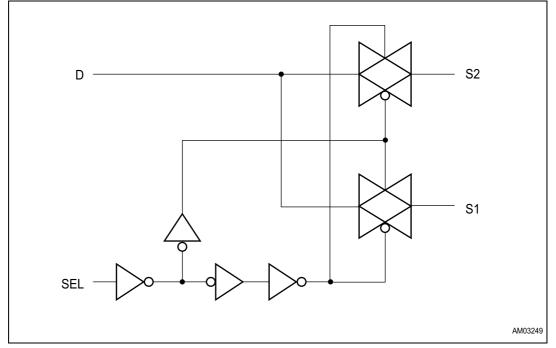


Table 3. Truth table

SEL	Switch S1	Switch S2
Н	ON	OFF <sup>(1)</sup>
L	OFF <sup>(1)</sup>	ON

1. High impedance.



### 3 Maximum ratings

Stressing the device above the rating listed in *Table 4* may cause permanent damage to the device. These are stress ratings only and operation of the device at these or any other conditions above those indicated in *Table 5* of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Refer also to the STMicroelectronics<sup>®</sup> SURE program and other relevant quality documents.

Symbol	Parameter	Value	Unit
V <sub>CC</sub>	Supply voltage	-0.5 to 5.5	V
VL	Logic supply voltage	-0.5 to 5.5	V
VI	DC input voltage	-0.5 to V <sub>CC</sub> + 0.5	V
V <sub>IC</sub>	DC control input voltage	-0.5 to V <sub>L</sub> + 5.5	V
Vo	DC output voltage	-0.5 to V <sub>CC</sub> + 0.5	V
I <sub>IKC</sub>	DC input diode current on control pin ( $V_{SEL} < 0 V$ )	- 50	mA
I <sub>IK</sub>	DC input diode current (V <sub>SEL</sub> < 0 V)	± 50	mA
I <sub>OK</sub>	DC output diode current	± 20	mA
Ι <sub>Ο</sub>	DC output current	± 300	mA
I <sub>OP</sub>	DC output current peak (pulse at 1 ms, 10% duty cycle)	± 500	mA
I <sub>CC</sub> or I <sub>GND</sub>	DC V <sub>CC</sub> or ground current	± 100	mA
PD	Power dissipation at $T_A = 70 \ ^{\circ}C^{(1)}$	500	mW
T <sub>stg</sub>	Storage temperature	-65 to 150	°C
TL	Lead temperature (10 sec.)	260	°C

Table 4. Absolute maximum ratings	Table 4.	Absolute	maximum	ratings
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1. Derate above 70 °C by 18.5 mW/C.

Table 5. Recommended	operating conditions
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Symbol	Parameter		Value	Unit
V <sub>CC</sub>	Supply voltage	1.65 to 4.8	V	
VL	Logic supply voltage <sup>(1)</sup>	1.65 to $V_{CC}$	V	
VI	Input voltage	0 to $V_{CC}$	V	
V <sub>IC</sub>	Control input voltage	0 to $V_L$	V	
Vo	Output voltage	0 to V <sub>CC</sub>	V	
T <sub>op</sub>	Operating temperature	-40 to 85	°C	
dt/dv	Input rise and fall time control input	$V_{L}$ = 1.65 to 2.7 V	0 to 20	ns/V
u/uv		V <sub>L</sub> = 3.0 to 4.8 V	0 to 10	115/ V

1.  $V_L$  pin should not be left floating.



# 4 Electrical characteristics

							Value			
Symbol	Parameter	V <sub>CC</sub> (V)	V <sub>L</sub> (V)	Test conditions	T <sub>A</sub> = 25 °C			-40 to 85 °C		Unit
					Min.	Тур.	Max.	Min.	Max.	
			1.65 – 1.95		1.25			1.25		
V	High level input	1.65 – 4.3	2.3 – 2.7		1.75			1.75		v
V <sub>IH</sub>	voltage	1.05 - 4.5	3.0 – 3.6		2.34			2.34		v
			4.3		2.80			2.80		
		1.65 – 1.95				0.6		0.6		
V <sub>IL</sub>	Low level input	1.65 – 4.3	2.3 – 2.7				0.8		0.8	v
۷L	voltage	1.05 - 4.5	3.0 – 3.6				1.05		1.05	v
			4.3				1.5		1.5	
R <sub>ON</sub> On-resistance	1.8				1.5	2.5		3.7		
	2.25				0.75	1.0		1.3		
	On-resistance	3	1.65 – 4.3	$V_S = 0 V \text{ to } V_{CC}$ I <sub>S</sub> = 100 mA		0.50	0.65		0.8	Ω
	3.7				0.45	0.55		0.7		
		4.3				0.40	0.5		0.65	
		1.8		$V_{S} = 0 V \text{ to } V_{CC}$ I <sub>S</sub> = 100 mA		40				mΩ
	On-resistance	2.25				20				
$\Delta R_{ON}$	match between	3	1.65 – 4.3			10				
	channels <sup>(1)</sup>	3.7				10				
		4.3				10				
		1.8				1.0	1.7		2.0	
		2.25				300	430		550	mΩ
R <sub>FLAT</sub>	On-resistance flatness <sup>(2)</sup>	3	1.65 – 4.3	V <sub>S</sub> = 0 V to V <sub>CC</sub> I <sub>S</sub> = 100 mA		150	190		270	
		3.7				140	180		230	
		4.3				140	180		220	
I <sub>OFF</sub>	Sn OFF state leakage current	4.3	4.3	$V_{\rm S}$ = 0.3 to 4.0 $V_{\rm D}$ = 0.3 to 4.0	-30		30	-300	300	nA
I <sub>ON</sub>	Sn ON state leakage current	4.3	4.3	V <sub>S</sub> = 0.3 to 4.0 V <sub>D</sub> = open	-30		30	-300	300	nA
I <sub>D</sub>	D ON state leakage current	4.3	4.3	$V_{S}$ = open $V_{D}$ = 0 to 4.0	-30		30	-300	300	nA

Table 6. DC specifications



		ter V <sub>CC</sub> (V) V <sub>L</sub> (V)			Value					
Symbol I	Parameter			Test conditions	T <sub>A</sub> = 25 °C			-40 to 85 °C		Unit
					Min.	Тур.	Max.	Min.	Max.	
I <sub>CC</sub>	Quiescent supply current	1.65 – 4.3	1.65 – 4.3	$V_{SEL} = V_{CC}$ or GND	-0.05		0.05	-0.2	0.2	μA
I <sub>SEL</sub>	SEL leakage current	1.65 – 4.3	1.65 – 4.3	V <sub>SEL</sub> = 4.3V or GND	-0.2		0.2	-2	2	μA

Table 6. DC specifications (continued)

1.  $\Delta R_{ON} = R_{ON(Max)} - R_{ON(Min)}$ .

Flatness is defined as the difference between the maximum and minimum value of on-resistance as measured over the specified analog signal ranges.

		Test conditions			Value																									
Symbol Para	Parameter			N 60		T <sub>A</sub> = 25 °C			85 °C	Unit																				
		V <sub>CC</sub> (V)	V <sub>L</sub> (V)		Min.	Тур.	Max.	Min.	Max.																					
		1.65 – 1.95				0.18																								
t <sub>PLH</sub> ,	t <sub>PLH</sub> , Propagation	2.3 – 2.7	1.65 – 4.3			0.14																								
t <sub>PHL</sub>	delay	3.0 – 3.3	1.05 – 4.5			0.12				ns																				
	3.6 - 4.3				0.12																									
t <sub>ON</sub> Turn-on time	1.65 – 1.95				70	123		160																						
	2.3 – 2.7	165 42	$V_{\rm S} = V_{\rm CC}$ 1.65 - 4.3 $R_{\rm L} = 50 \ \Omega$		48	62		80	ns																					
		3 – 3.6	1.00 - 4.0	1.00 - 4.0	$C_1 = 30 \text{ pF}$		33	43		56	115																			
		4.3				29	38		49																					
	tore Turn-off time	1.65 – 1.95	• 1.65 – 4.3	V <sub>S</sub> = V <sub>CC</sub> 1.65 – 4.3 R <sub>L</sub> = 50 Ω		36	45		60																					
t <sub>OFF</sub>		2.3 – 2.7			$V_{\rm S} = V_{\rm S}$	$V_{\rm S} = V_{\rm CC}$ 3 R <sub>1</sub> = 50 O		35	47		62	ns																		
OFF		3 – 3.6		$C_L = 30 \text{ pF}$		30	40		51																					
		4.3																									29	38		50
		1.65 – 1.95						10	42																					
t <sub>D</sub>	Break-before- make time	2.3 – 2.7	165-43	C <sub>L</sub> = 35 pF R <sub>L</sub> = 50 Ω	10	22				ns																				
<u>ں</u>	delay	3 – 3.6		$V_{\rm S} = V_{\rm CC}/2$	5	15																								
		4.3			5	12																								
		1.65 – 1.95				75				pC																				
Q	Charge	2.3 – 2.7	165-43	C <sub>L</sub> = 1 nF V <sub>GEN</sub> = 0 V		98																								
3	injection	3.0 – 3.3	1.00 4.0	V <sub>GEN</sub> = 0 V		133																								
		3.6 – 4.3				162																								

Table 7. AC electrical characteristics (C  $_L$  = 35 pF, R  $_L$  = 50  $\Omega$ , t  $_r$  = t  $_f \leq \,$  5 ns)



	Parameter	Test conditions			Value					
Symbol		V <sub>CC</sub> (V)	V <sub>L</sub> (V)		T <sub>A</sub> = 25 °C		-40 to 85 °C		Unit	
					Min.	Тур.	Max.	Min.	Max.	-
OIRR	OFF-isolation <sup>(1)</sup>	1.65 – 4.3	4.3	V <sub>S</sub> = 1 V <sub>RMS</sub> f = 100 kHz		77				dB
				$V_{S} = 1 V_{RMS}$ f = 1 MHz		67				
				$V_{S} = 1 V_{RMS}$ f = 5 MHz		50				
Xtalk	Crosstalk	1.65 – 4.3	4.3	$V_{S} = 1 V_{RMS}$ f = 100 kHz		80				dB
				$V_{S} = 1 V_{RMS}$ f = 1 MHz		67				
				$V_{S}$ = 1 $V_{RMS}$ f = 5 MHz		50				
THD	Total harmonic distortion	2.3 – 4.3	4.3	$R_L$ = 600 Ω $C_L$ = 50 pF $V_S$ = $V_{CC}$ f = 600 Hz to 20 kHz		0.01				%
BW	-3 dB Bandwidth (switch ON)	1.65 – 4.3	4.3	R <sub>L</sub> = 50 Ω		50				MHz

1. OFF-isolation = 20  $\log_{10}$  (V<sub>D</sub>/V<sub>S</sub>), V<sub>D</sub> = output, V<sub>S</sub> = input to off switch.

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		т		20			Value			
Symbol	Parameter	Test conditions			Value					
		V <sub>cc</sub> (V)	V <sub>L</sub> (V)		T <sub>A</sub> = 25 °C		-40 to 85 °C		Unit	
					Min.	Тур.	Max.	Min.	Max.	
C <sub>SEL</sub>	Control pin input capacitance	1.8 – 4.3	1.8 – 4.3	V <sub>L</sub> = V <sub>CC</sub>		30				pF
C <sub>SN</sub>	Sn port capacitance	1.8 – 4.3	1.8 – 4.3	$V_L = V_{CC}$		94				pF
CD	D port capacitance when the switch is enabled	1.8 – 4.3	1.8 – 4.3	V <sub>L</sub> = V <sub>CC</sub>		227				pF



## 5 Test circuits

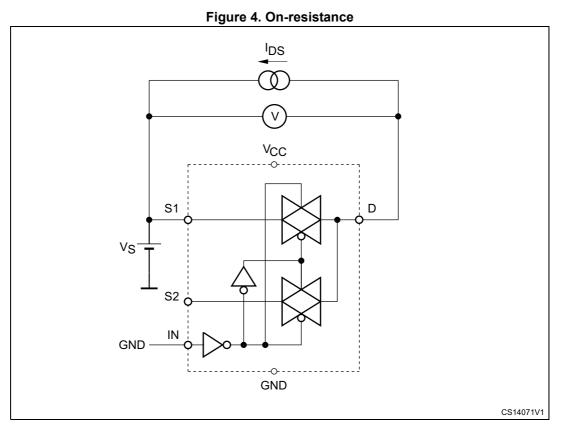
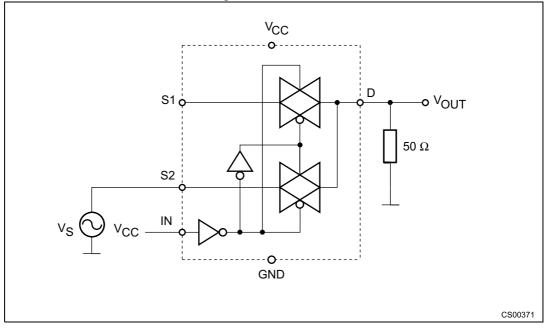
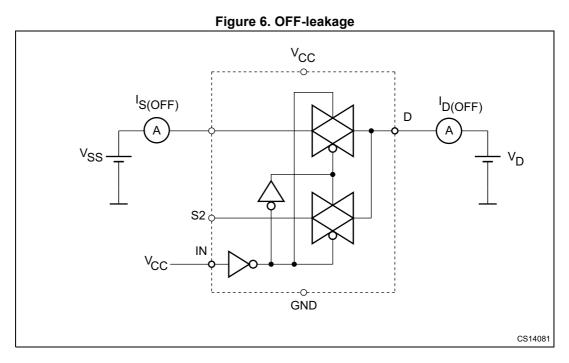
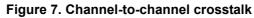


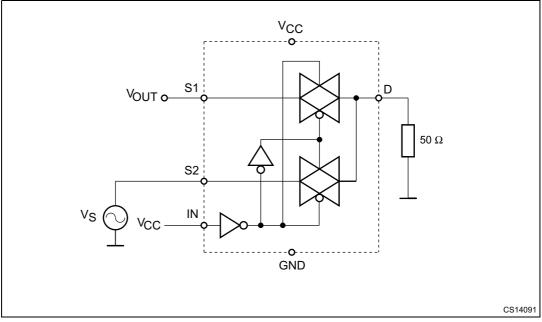
Figure 5. Bandwidth



57









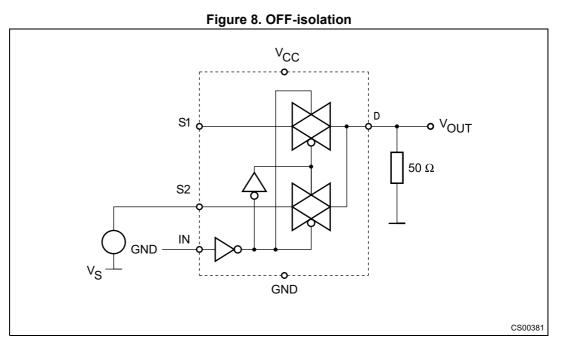
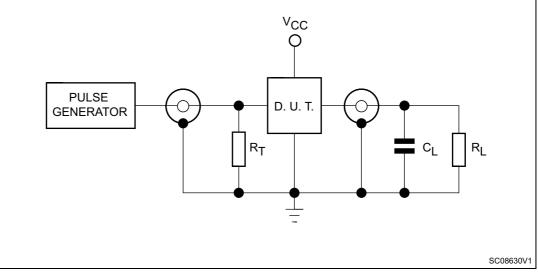


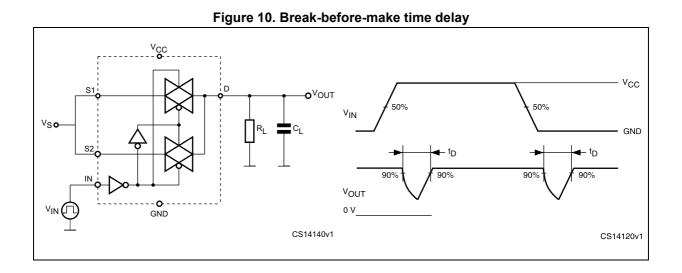
Figure 9. Test circuit

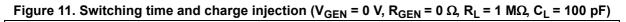


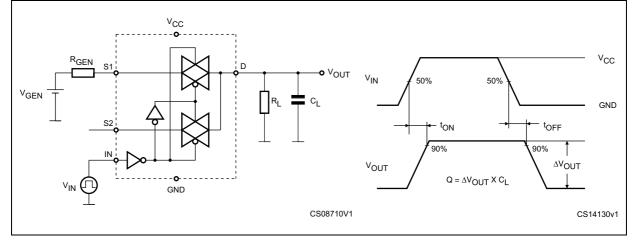
1.  $C_L = 5/35 \text{ pF}$  or equivalent (includes jig capacitance).

- 2.  $R_L = 50 \Omega$  or equivalent.
- 3.  $R_T = Z_{OUT}$  of pulse generator (typically 50  $\Omega$ ).

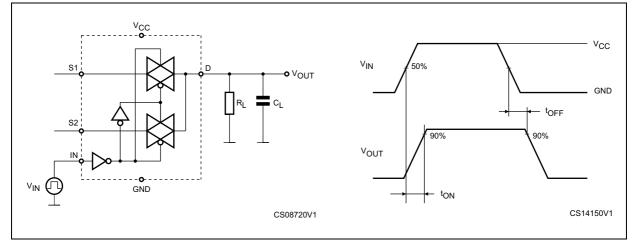








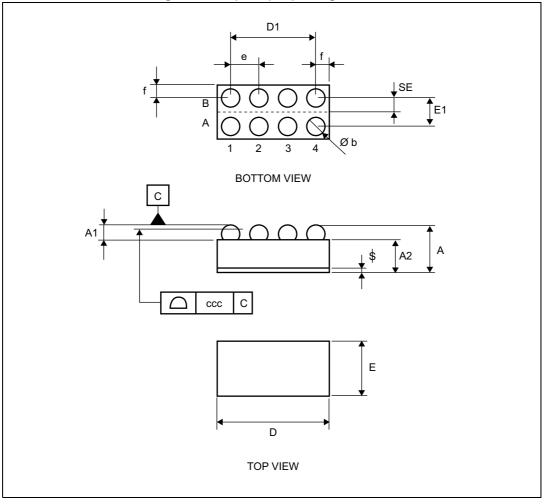
#### Figure 12. Turn-on, turn-off delay time



### 6 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK is an ST trademark.

Figure 13. Flip Chip 8 package outline



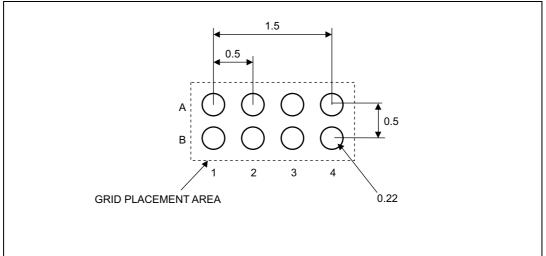
1. Drawing is not to scale.



Table 5. Filp Chilp o mechanical data							
Cumhal	Dimensions (mm)						
Symbol	Min.	Тур.	Max.				
A	0.535	0.58	0.625				
A1	0.18	0.205	0.23				
A2	0.355	0.375	0.395				
b	0.215	0.255	0.295				
D	1.85	1.9	1.95				
D1		1.5					
е	0.45	0.5	0.55				
E	0.85	0.9	0.95				
E1	0.45	0.5	0.55				
SE		0.25					
f	0.19	0.2	0.21				
CCC		0.08					

Table 9. Flip Chip 8 mechanical data

#### Figure 14. Flip Chip 8 footprint





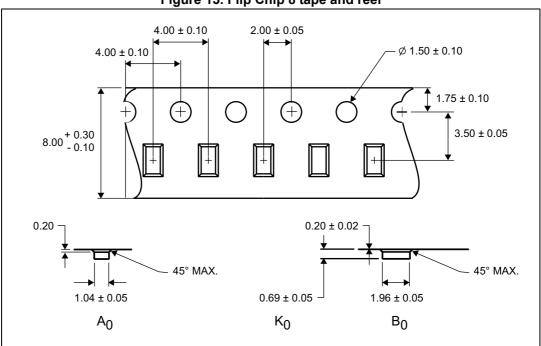
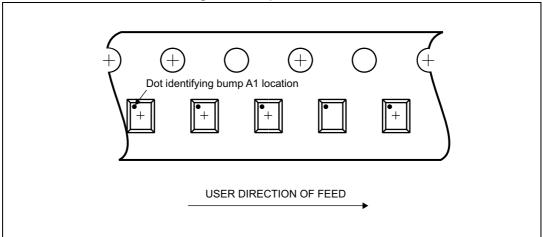


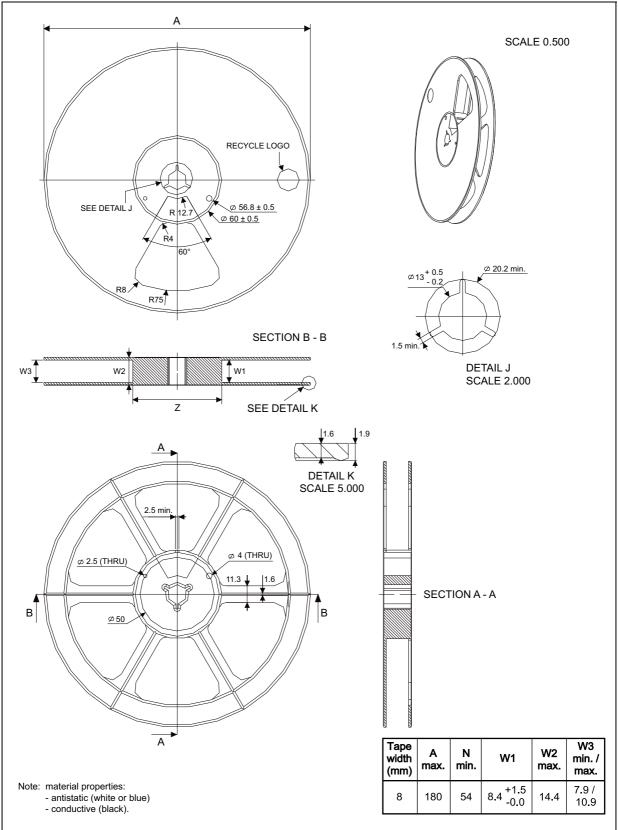
Figure 15. Flip Chip 8 tape and reel

#### Figure 16. Tape orientation











# 7 Package marking information

Marking composition: Flip Chip 8					
Package face: top	Legend				
	<ul> <li>Unmarkable surface</li> <li>Marking composition field</li> <li>A - 53312 - dot</li> <li>B - 53313 - standard ST logo (0000093)</li> <li>C - 53323 - ECO level</li> <li>D - 53314 - marking area</li> <li>E - 53318 - additional information (max. char. allowed = 1)</li> <li>F - 53319 - Assembly year (Y)</li> <li>G - 53322 - Assembly week (WW)</li> </ul>				

#### Table 10. Device topside marking information



# 8 Revision history

Date	Revision	Changes
11-Sep-2008	1	Initial release.
19-Feb-2009	2	Updated: I <sub>ON</sub> values in <i>Table 6: DC specifications</i> .
15-May-2013	3	Slightly redrawn <i>Figure 3</i> to <i>Figure 15</i> and <i>Figure 17</i> . Updated <i>Figure 16</i> (added "Dot identifying bump A1 location"). Updated <i>Section 3: Maximum ratings</i> (added cross-references). Corrected units in <i>Table 8</i> . Updated <i>Section 6: Package mechanical data</i> (updated ECOPACK text). Added <i>Section 7: Package marking information</i> . Minor corrections throughout document.

#### Table 11. Document revision history



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